## N-Channel 100-V (D-S) MOSFET

| PRODUCT SUMMARY |  |  |
| :---: | :---: | :---: |
| $\mathbf{V}_{(\mathbf{B R}) \mathrm{DSs}}(\mathbf{V})$ | $\mathbf{r}_{\mathrm{DS}(\mathrm{on})}(\Omega)$ | $\mathbf{I}_{\mathbf{D}}(\mathbf{A})$ |
| 100 | 0.017 at $\mathrm{V}_{\mathrm{GS}}=10 \mathrm{~V}$ | 30 |

## FEATURES

- TrenchFET ${ }^{\circledR}$ Power MOSFET
- $175{ }^{\circ} \mathrm{C}$ Junction Temperature
- Low Thermal Resistance Package
- $100 \% \mathrm{R}_{\mathrm{g}}$ Tested


## APPLICATIONS

- Isolated DC/DC Converters


N-Channel MOSFET

| ABSOLUTE MAXIMUM RATINGS ( $\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$, unless otherwise noted) |  |  |  |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: |
| PARAMETER |  | SYMBOL | LIMIT |  | UNIT |
| Drain-source voltage |  | $V_{\text {DS }}$ |  |  | V |
| Gate-source voltage |  | $\mathrm{V}_{\mathrm{GS}}$ | $\pm 20$ |  |  |
| Continuous drain current ( $\left.\mathrm{T}_{J}=150{ }^{\circ} \mathrm{C}\right)$ | $\mathrm{T}_{\mathrm{C}}=25^{\circ} \mathrm{C}$ | ID | 30 |  |  |
|  | $\mathrm{T}_{\mathrm{C}}=70^{\circ} \mathrm{C}$ |  | 19 |  |  |
|  | $\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$ |  | $10^{\text {b, c }}$ |  |  |
|  | $\mathrm{T}_{\mathrm{A}}=70^{\circ} \mathrm{C}$ |  | $8.5{ }^{\text {b, c }}$ |  |  |
| Pulsed drain current ( $\mathrm{t}=100 \mu \mathrm{~s}$ ) |  | IDM |  |  | A |
| Continuous source-drain diode current | $\mathrm{T}_{\mathrm{C}}=25^{\circ} \mathrm{C}$ | Is | 56 |  |  |
|  | $\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$ |  |  |  |  |
| Single pulse avalanche current | L $=0.1 \mathrm{mH}$ | $\mathrm{I}_{\text {AS }}$ |  |  |  |
| Single pulse avalanche energy | $\mathrm{L}=0.1 \mathrm{mH}$ | $\mathrm{E}_{\text {AS }}$ |  |  | mJ |
|  | $\mathrm{T}_{\mathrm{C}}=25^{\circ} \mathrm{C}$ |  |  |  |  |
| Maximum power dissipation | $\mathrm{T}_{\mathrm{C}}=70^{\circ} \mathrm{C}$ |  |  |  |  |
| Maximum power dissipation | $\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$ | $\mathrm{P}_{\mathrm{D}}$ |  |  | W |
|  | $\mathrm{T}_{\mathrm{A}}=70^{\circ} \mathrm{C}$ |  |  |  |  |
| Operating junction and storage tempera |  | $\mathrm{T}_{\mathrm{J}}, \mathrm{T}_{\text {stg }}$ |  |  | ${ }^{\circ} \mathrm{C}$ |
| Soldering recommendations (peak temp |  |  |  |  |  |
| THERMAL RESISTANCE RA |  |  |  |  |  |
| PARAMETER |  | SYMBOL | TYPICAL | MAXIMUM | UNIT |
| Maximum junction-to-ambient ${ }^{\text {b }}$ | $\mathrm{t} \leq 10 \mathrm{~s}$ | $\mathrm{R}_{\text {thJA }}$ | 20 | 25 | W |
| Maximum junction-to-case (drain) | Steady state | $\mathrm{R}_{\text {thJC }}$ | 1.6 | 2 | , |

## Notes

a. Package limited
b. Surface mounted on $1^{\prime \prime} \times 1^{\prime \prime}$ FR4 board
c. $t=10 \mathrm{~s}$

| SPECIFICATIONS $\left(T_{J}=25{ }^{\circ} \mathrm{C}\right.$, unless otherwise noted) |  |  |  |  |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| PARAMETER | SYMBOL | TEST CONDITIONS | MIN. | TYP. | MAX. | UNIT |
| Static |  |  |  |  |  |  |
| Drain-source breakdown voltage | $\mathrm{V}_{\mathrm{DS}}$ | $\mathrm{V}_{\mathrm{GS}}=0 \mathrm{~V}, \mathrm{I}_{\mathrm{D}}=250 \mu \mathrm{~A}$ | 100 | - | - | V |
| $\mathrm{V}_{\text {DS }}$ temperature coefficient | $\Delta \mathrm{V}_{\mathrm{DS}} / \mathrm{T}_{\mathrm{J}}$ | $\mathrm{I}_{\mathrm{D}}=10 \mathrm{~mA}$ | - | 81 | - | $\mathrm{mV} /{ }^{\circ} \mathrm{C}$ |
| $\mathrm{V}_{\mathrm{GS}(\text { th) }}$ temperature coefficient | $\Delta \mathrm{V}_{\mathrm{GS}(\mathrm{th})} \mathrm{T}_{\mathrm{J}}$ | $\mathrm{I}_{\mathrm{D}}=250 \mu \mathrm{~A}$ | - | -7.5 | - |  |
| Gate-source threshold voltage | $\mathrm{V}_{\mathrm{GS}(\mathrm{th})}$ | $\mathrm{V}_{\mathrm{DS}}=\mathrm{V}_{\mathrm{GS}}, \mathrm{I}_{\mathrm{D}}=250 \mu \mathrm{~A}$ | 3 | - | 5 | V |
| Gate-source leakage | $\mathrm{I}_{\text {GSS }}$ | $\mathrm{V}_{\mathrm{DS}}=0 \mathrm{~V}, \mathrm{~V}_{\mathrm{GS}}= \pm 20 \mathrm{~V}$ | - | - | 100 | nA |
| Zero gate voltage drain current | Idss | $\mathrm{V}_{\mathrm{DS}}=100 \mathrm{~V}, \mathrm{~V}_{\mathrm{GS}}=0 \mathrm{~V}$ | - | - | 1 | $\mu \mathrm{A}$ |
|  |  | $\mathrm{V}_{\mathrm{DS}}=100 \mathrm{~V}, \mathrm{~V}_{\mathrm{GS}}=0 \mathrm{~V}, \mathrm{~T}_{\mathrm{J}}=70^{\circ} \mathrm{C}$ | - | - | 15 |  |
| On-state drain current ${ }^{\text {a }}$ | $\mathrm{I}_{\mathrm{D} \text { (on) }}$ | $\mathrm{V}_{\mathrm{DS}} \geq 10 \mathrm{~V}, \mathrm{~V}_{\mathrm{GS}}=10 \mathrm{~V}$ | 40 | - | - | A |
| Drain-source on-state resistance ${ }^{\text {a }}$ | $\mathrm{R}_{\mathrm{DS} \text { (on) }}$ | $\mathrm{V}_{\mathrm{GS}}=10 \mathrm{~V}, \mathrm{I}_{\mathrm{D}}=10 \mathrm{~A}$ | - | 0.0170 | - | $\Omega$ |
|  |  | $\mathrm{V}_{\mathrm{GS}}=7.5 \mathrm{~V}, \mathrm{I}_{\mathrm{D}}=10 \mathrm{~A}$ | - | 0.0200 | - |  |
| Forward transconductance ${ }^{\text {a }}$ | $\mathrm{g}_{\text {fs }}$ | $\mathrm{V}_{\mathrm{DS}}=15 \mathrm{~V}, \mathrm{I}_{\mathrm{D}}=10 \mathrm{~A}$ | - | 46 | - | S |
| Dynamic ${ }^{\text {b }}$ |  |  |  |  |  |  |
| Input capacitance | $\mathrm{C}_{\text {iss }}$ | $\mathrm{V}_{\mathrm{DS}}=50 \mathrm{~V}, \mathrm{~V}_{\mathrm{GS}}=0 \mathrm{~V}, \mathrm{f}=1 \mathrm{MHz}$ | - | 1470 | - | pF |
| Output capacitance | $\mathrm{C}_{\text {oss }}$ |  | - | 132 | - |  |
| Reverse transfer capacitance | $\mathrm{C}_{\text {rss }}$ |  | - | 11.2 | - |  |
| Total gate charge | $\mathrm{Q}_{\mathrm{g}}$ | $\mathrm{V}_{\mathrm{DS}}=50 \mathrm{~V}, \mathrm{~V}_{\mathrm{GS}}=10 \mathrm{~V}, \mathrm{I}_{\mathrm{D}}=10 \mathrm{~A}$ | - | 20 | - | nC |
|  |  | $\mathrm{V}_{\mathrm{DS}}=50 \mathrm{~V}, \mathrm{~V}_{\mathrm{GS}}=7.5 \mathrm{~V}, \mathrm{I}_{\mathrm{D}}=10 \mathrm{~A}$ | - | 15 | - |  |
| Gate-source charge | $\mathrm{Q}_{\mathrm{gs}}$ |  | - | 6.45 | - |  |
| Gate-drain charge | $\mathrm{Q}_{\mathrm{gd}}$ |  | - | 3.5 | - |  |
| Output charge | $\mathrm{Q}_{\text {oss }}$ | $\mathrm{V}_{\mathrm{DS}}=50 \mathrm{~V}, \mathrm{~V}_{\mathrm{GS}}=0 \mathrm{~V}$ | - | 22 | - |  |
| Gate resistance | $\mathrm{R}_{\mathrm{g}}$ | $\mathrm{f}=1 \mathrm{MHz}$ | 0.2 | 0.76 | 1.4 | $\Omega$ |
| Turn-on delay time | $\mathrm{t}_{\mathrm{d}(\mathrm{on})}$ | $\begin{gathered} \mathrm{V}_{\mathrm{DD}}=50 \mathrm{~V}, \mathrm{R}_{\mathrm{L}}=5 \Omega, \mathrm{I}_{\mathrm{D}} \cong 10 \mathrm{~A}, \\ \mathrm{~V}_{\mathrm{GEN}}=10 \mathrm{~V}, \mathrm{R}_{\mathrm{g}}=1 \Omega \end{gathered}$ | - | 12 | 24 | ns |
| Rise time | $t_{r}$ |  | - | 5 | 10 |  |
| Turn-off delay time | $\mathrm{t}_{\text {d(off) }}$ |  | - | 19 | 38 |  |
| Fall time | $\mathrm{t}_{\mathrm{f}}$ |  | - | 5 | 10 |  |
| Turn-on delay time | $\mathrm{t}_{\mathrm{d}(\mathrm{on})}$ | $\begin{gathered} \mathrm{V}_{\mathrm{DD}}=50 \mathrm{~V}, \mathrm{R}_{\mathrm{L}}=5 \Omega, \mathrm{I}_{\mathrm{D}} \cong 10 \mathrm{~A}, \\ \mathrm{~V}_{\mathrm{GEN}}=7.5 \mathrm{~V}, \mathrm{R}_{\mathrm{g}}=1 \Omega \end{gathered}$ | - | 15 | 30 |  |
| Rise time | $\mathrm{t}_{\mathrm{r}}$ |  | - | 6 | 12 |  |
| Turn-off delay time | $\mathrm{t}_{\mathrm{d}(\mathrm{off})}$ |  | - | 19 | 38 |  |
| Fall time | $\mathrm{t}_{\mathrm{f}}$ |  | - | 5 | 10 |  |
| Drain-Source Body Diode Characteristics |  |  |  |  |  |  |
| Continuous source-drain diode current | $\mathrm{I}_{\mathrm{s}}$ | $\mathrm{T}_{\mathrm{C}}=25^{\circ} \mathrm{C}$ | - | - | 56.8 | A |
| Pulse diode forward current | $I_{\text {SM }}$ |  | - | - | 80 |  |
| Body diode voltage | $\mathrm{V}_{\mathrm{SD}}$ | $\mathrm{I}_{\mathrm{S}}=5 \mathrm{~A}, \mathrm{~V} \mathrm{VS}=0 \mathrm{~V}$ | - | 0.78 | 1.1 | V |
| Body diode reverse recovery time | $\mathrm{t}_{\mathrm{rr}}$ | $\mathrm{I}_{\mathrm{F}}=10 \mathrm{~A}, \mathrm{di} / \mathrm{dt}=100 \mathrm{~A} / \mu \mathrm{s}, \mathrm{T}_{\mathrm{J}}=25^{\circ} \mathrm{C}$ | - | 43 | 86 | ns |
| Body diode reverse recovery charge | $\mathrm{Q}_{\mathrm{rr}}$ |  | - | 72 | 144 | nC |
| Reverse recovery fall time | $\mathrm{t}_{\mathrm{a}}$ |  | - | 33 | - |  |
| Reverse recovery rise time | $\mathrm{t}_{\mathrm{b}}$ |  | - | 10 | - | ns |

## Notes

a. Pulse test; pulse width $\leq 300 \mu \mathrm{~s}$, duty cycle $\leq 2 \%$
b. Guaranteed by design, not subject to production testing

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

TYPICAL CHARACTERISTICS $\left(25^{\circ} \mathrm{C}\right.$, unless otherwise noted)


Output Characteristics


On-Resistance vs. Drain Current and Gate Voltage


Gate Charge


Transfer Characteristics


Capacitance


On-Resistance vs. Junction Temperature

TYPICAL CHARACTERISTICS $\left(25^{\circ} \mathrm{C}\right.$, unless otherwise noted)



Safe Operating Area, Junction-to-Ambient

TYPICAL CHARACTERISTICS $\left(25^{\circ} \mathrm{C}\right.$, unless otherwise noted)


Current Derating a


## Note

a. The power dissipation $P_{D}$ is based on $T_{J} \max .=150^{\circ} \mathrm{C}$, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit

TYPICAL CHARACTERISTICS $\left(25^{\circ} \mathrm{C}\right.$, unless otherwise noted)


Normalized Thermal Transient Impedance, Junction-to-Ambient


Normalized Thermal Transient Impedance, Junction-to-Case

VBsemi



UNIT: mm
NOTE

1. PACKAGE BODY SIZES EXCLUDE MOLD FLASH AND GATE BURRS.

MOLD FLASH AT THE NON-LEAD SIDES SHOULD BE LESS THAN 6 MILS EACH.
2. CONTROLLING DIMENSION IS MILLIMETER.

CONVERTED INCH DIMENSIONS ARE NOT NECESSARILY EXACT.

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